

40V P-Channel Enhancement Mode MOSFET

- **Features**

- -40V/-10A, $R_{DS(ON)}=38m@V_{GS}=-10V$
- -40V/ -8A, $R_{DS(ON)}=54m @V_{GS}= -4.5V$
- Super high density cell design for extremely
- low $R_{DS(ON)}$
- TO-252-2L package design

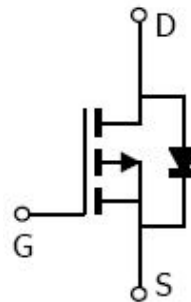
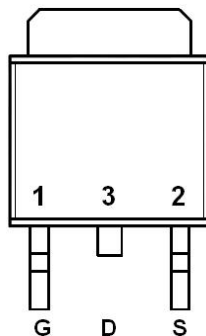
- **Applications**

- Backlight Inverter for LCD Display
- Full Bridge DC/DC Converter
- LED Display
- Load Switch
- CCFL Inverter

- **General Description**

LSP52H, P-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge. These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

- **Pin Description (TO-252-2L)**



● **Absolute Maximum Ratings**($T_A=25^\circ\text{C}$ Unless otherwise noted)

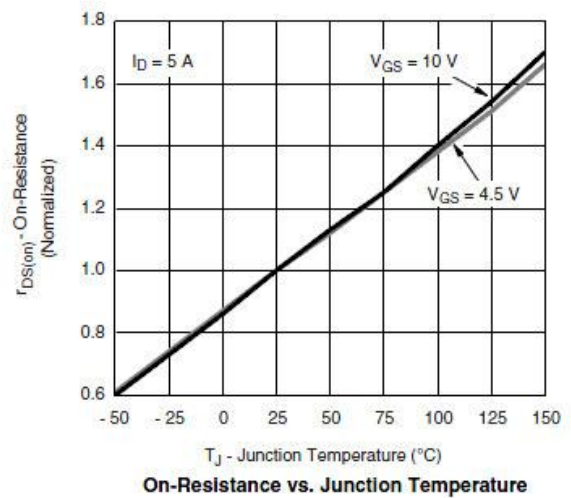
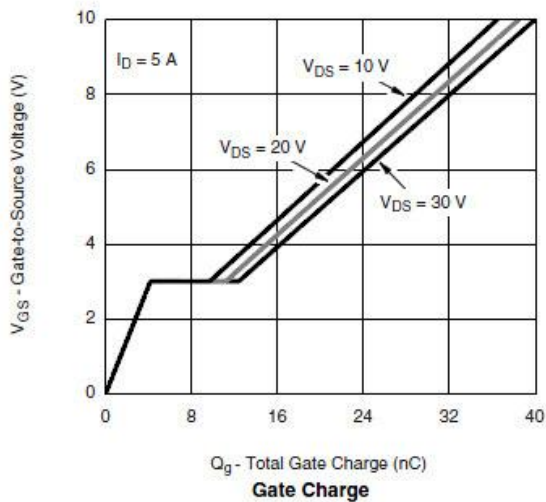
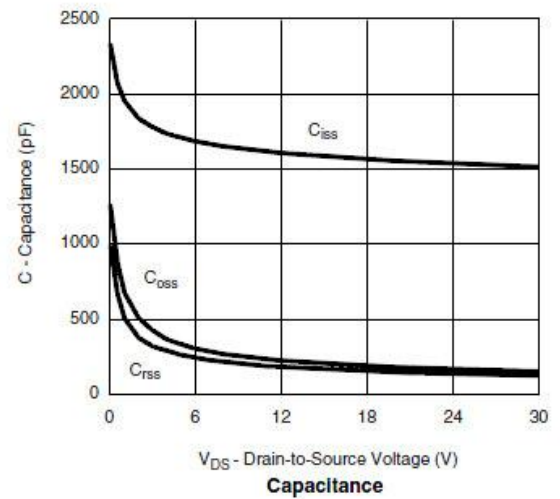
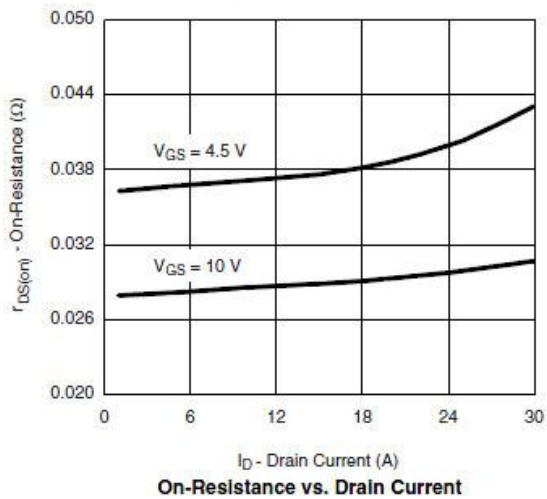
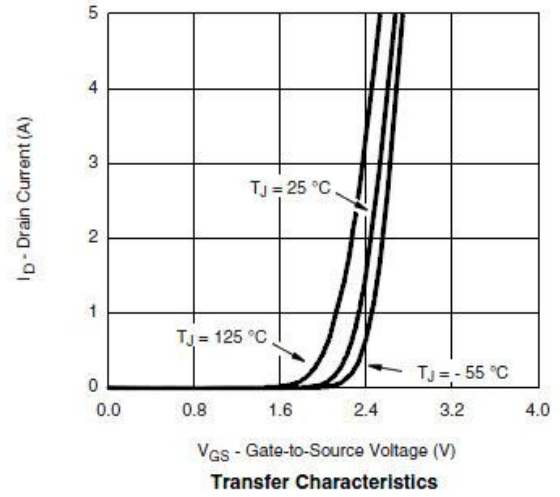
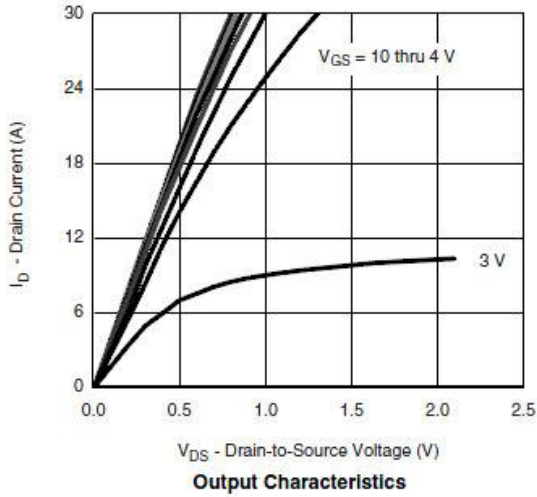
Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V_{DSS}	-40	V
Gate –Source Voltage		V_{GSS}	± 20	
Continuous Drain Current($T_J=150^\circ\text{C}$)	$T_A=25^\circ\text{C}$	I_D	-22	A
	$T_A=70^\circ\text{C}$		-16	
Pulsed Drain Current		I_{DM}	-30	
Continuous Source-Drain Diode Current		I_S	-8	
Single Pulse Avalanche Current	$L = 0.1 \text{ mH}$	I_{AS}	-30	
Avalanche Energy		E_{AS}	35	mJ
Power Dissipation	$T_A=25^\circ\text{C}$	P_D	40	W
	$T_A=70^\circ\text{C}$		15	
Operating Junction Temperature		T_J	150	$^\circ\text{C}$
Storage Temperature Range		T_{STG}	-55/150	
Thermal Resistance-Junction to Ambient		R_{JA}	62.5	$^\circ\text{C/W}$

● **Electrical Characteristics**($T_A=25^\circ\text{C}$ Unless otherwise noted)

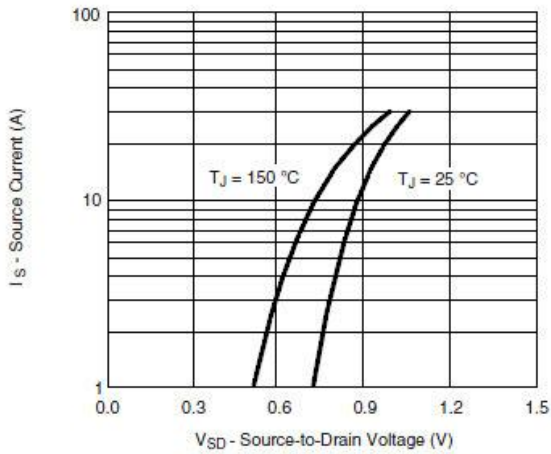
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D = -250\mu\text{A}$	-40			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D = -250\mu\text{A}$	-1.0		-3.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -32V, V_{GS} = 0V$			-1	uA
		$V_{DS} = -32V, V_{GS} = 0V, T_J = 85^\circ\text{C}$			-20	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \geq -5V, V_{GS} = -10V$	-20			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = -10V, I_D = 10A$		32	38	m Ω
		$V_{GS} = -4.5V, I_D = -8A$		42	54	
Forward Transconductance	g_{FS}	$V_{DS} = -15V, I_D = -5A$		20		S
Diode Forward Voltage	V_{SD}	$I_S = -2A, V_{GS} = 0V$		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS} = -20V, V_{GS} = -4.5V, I_D = -5.0A$		13	20	nC
Gate-Source Charge	Q_{gs}			4.5		
Gate-Drain Charge	Q_{gd}			6.5		
Input Capacitance	C_{iss}	$V_{DS} = -20V, V_{GS} = 0V, f = 1\text{MHz}$		1100		pF
Output Capacitance	C_{oss}			145		
Reverse Transfer Capacitance	C_{rss}			115		
Turn-On Time	$t_{d(on)}$	$V_{DD} = -20V, R_L = 4\Omega, I_D = -5.0A,$ $V_{GEN} = -4.5V, R_G = 1\Omega$		40	80	ns
	t_r			55	100	
Turn-Off Time	$t_{d(off)}$			30	60	
	t_f		12	20		

LSP52H

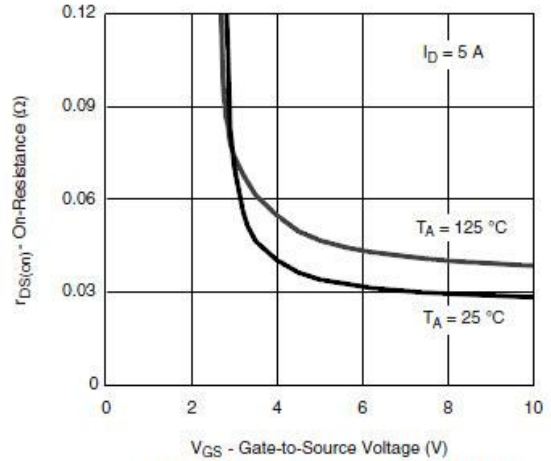
- Typical Characteristics



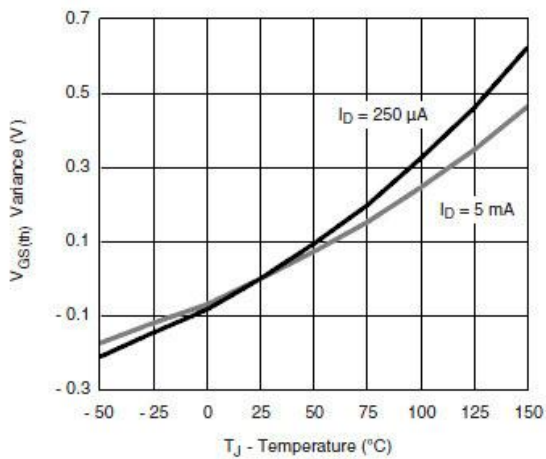
- Typical Characteristics



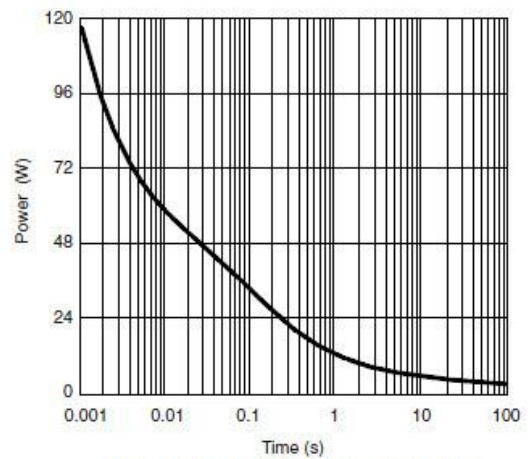
Source-Drain Diode Forward Voltage



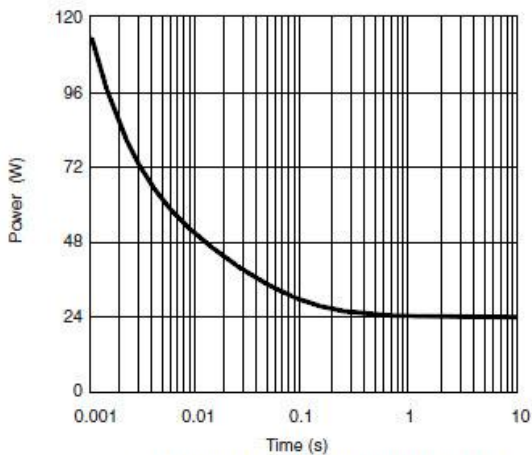
On-Resistance vs. Gate-to-Source Voltage



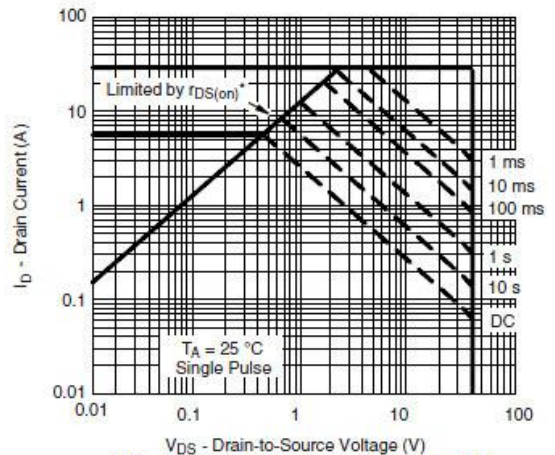
Threshold Voltage



Single Pulse Power, Junction-to-Ambient

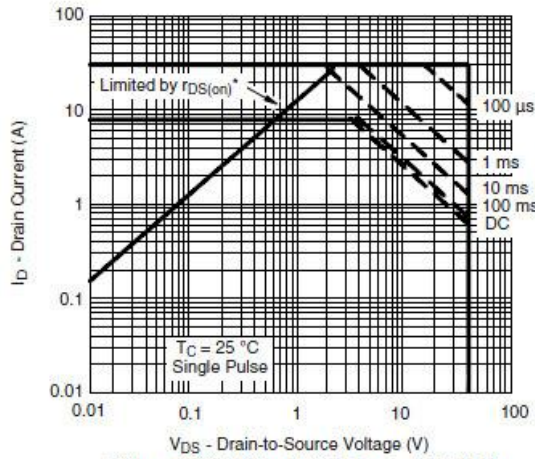


Single Pulse Power, Junction-to-Case

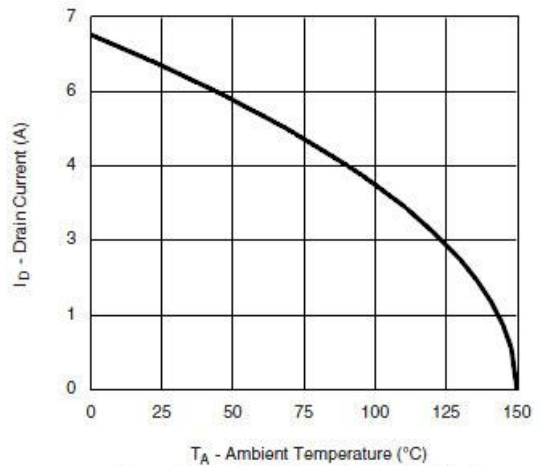


Safe Operating Area, Junction-to-Ambient

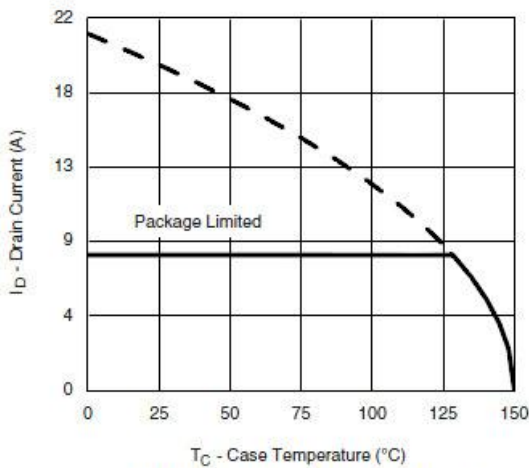
- Typical Characteristics



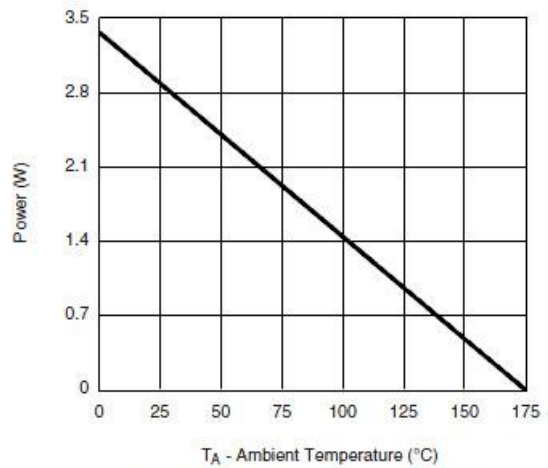
* $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified
Safe Operating Area, Junction-to-Case



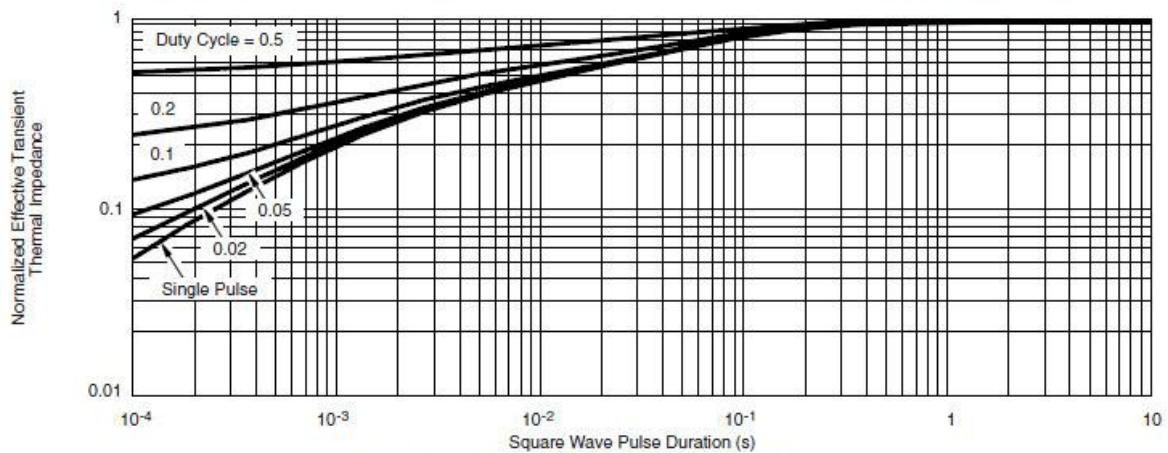
Current Derating*, Junction-to-Ambient



Current Derating*, Junction-to-Case



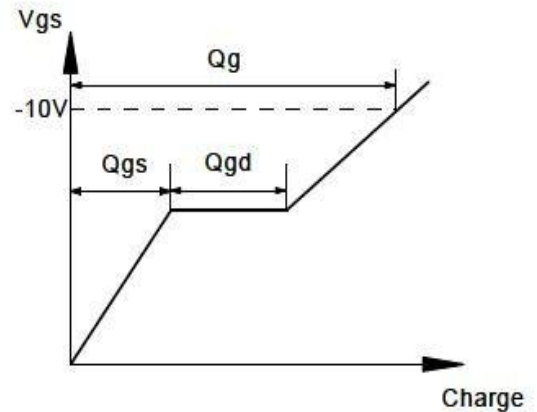
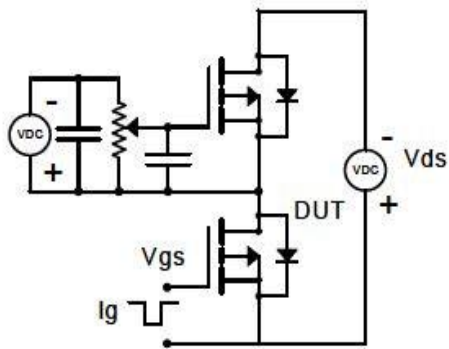
Power Derating*, Junction-to-Ambient



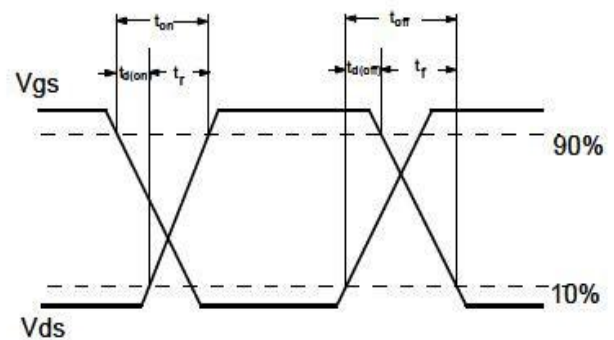
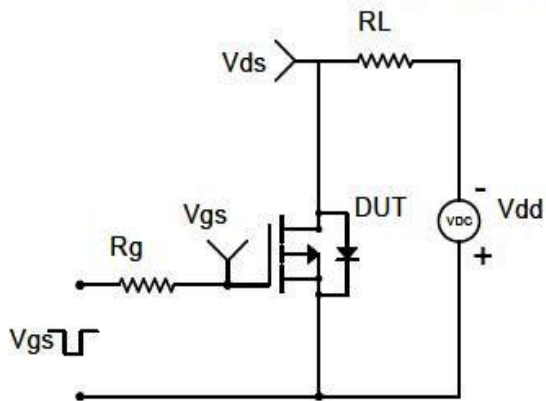
Normalized Thermal Transient Impedance, Junction-to-Case

- Typical Characteristics

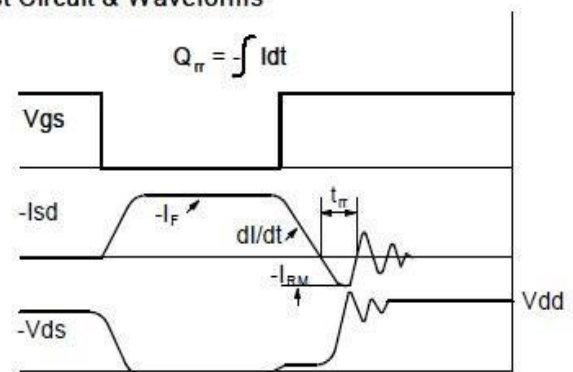
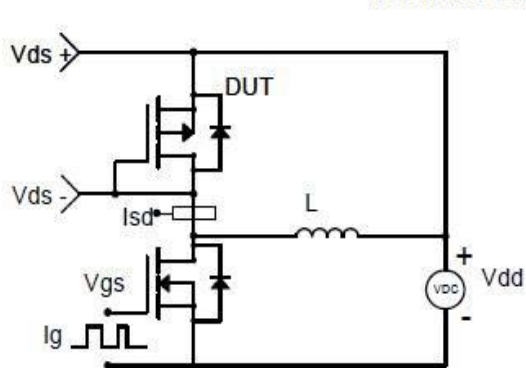
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

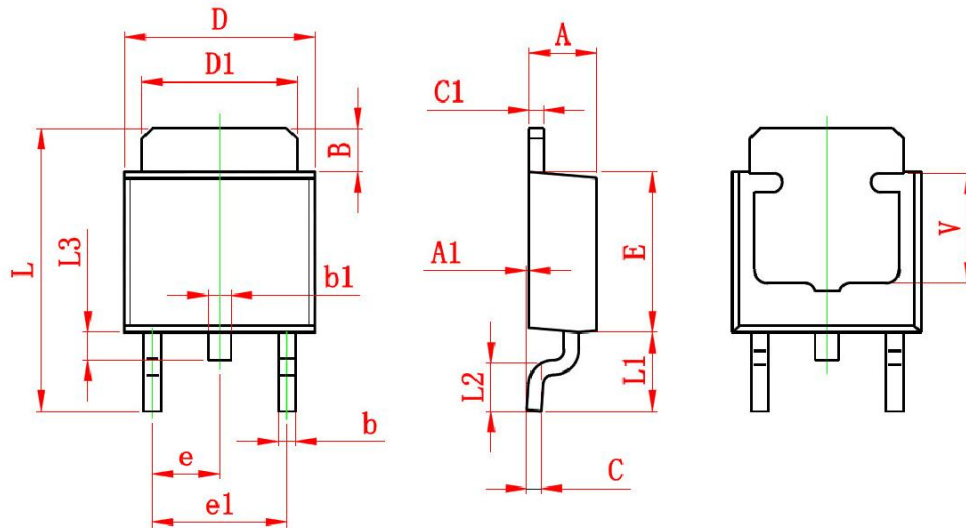


Diode Recovery Test Circuit & Waveforms



LSP52H

- Package Information (TO-252-2L)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	